

BRCs060N04SZCQ

Rev.A Sep.-2022

/ Descriptions

PDFN5 6 N

N-Channel MOSFET in a PDFN5 6 Plastic Package.

/ Features

AEC-Q101

Low $R_{DS(ON)}$ to minimize conductive loss; low Gate Charge for fast switching; Low Thermal resistance; Qualified to AEC-Q101 Standards for High Reliability; HF Product.

/ Applications

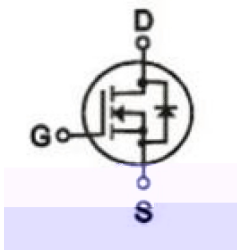
MB/NB/UMPC/VGA

Buck

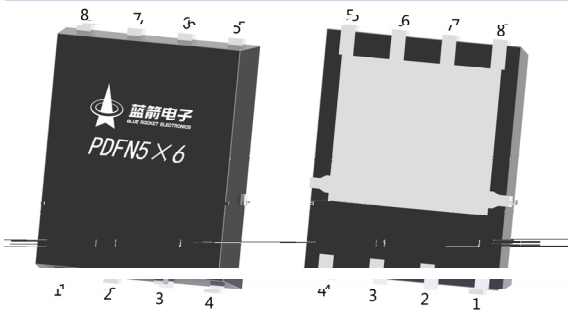
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Battery Management, High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA, Networking DC-DC Power System, Load Switch, Meet the stringent requirements of automotive applications.

/ Equivalent Circuit



/ Pinning



PIN1、2、3: S PIN4: G PIN5、6、7、8: D

Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	D
8	D

/ Marking

- See Marking Instructions.

/ Absolute Maximum Ratings($T_a=25$)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	40	V	
Drain Current - Continuous	I_D	30	A	
Drain Current – Pulsed	I_{DM}	110	A	
Gate-Source Voltage	V_{GS}	$\pm 20V$	V	
Power Dissipation	$P_D(T_c=25^\circ C)$	36.5	W	
Single Pulse Avalanche Energy(L=0.5mH)	E_{AS}	78.5	mJ	
Avalanche Current(L=0.5mH)	I_{AS}	15	A	
Junction and Storage Temperature Range	T_j, T_{stg}	-55 to 150		
Thermal resistance, junction - ambient	$t \leq 10s$	$R_{\theta JA}$	25	/ W
	Steady-State		55	
Thermal resistance, junction - case	Steady-State	$R_{\theta JC}$	3.4	

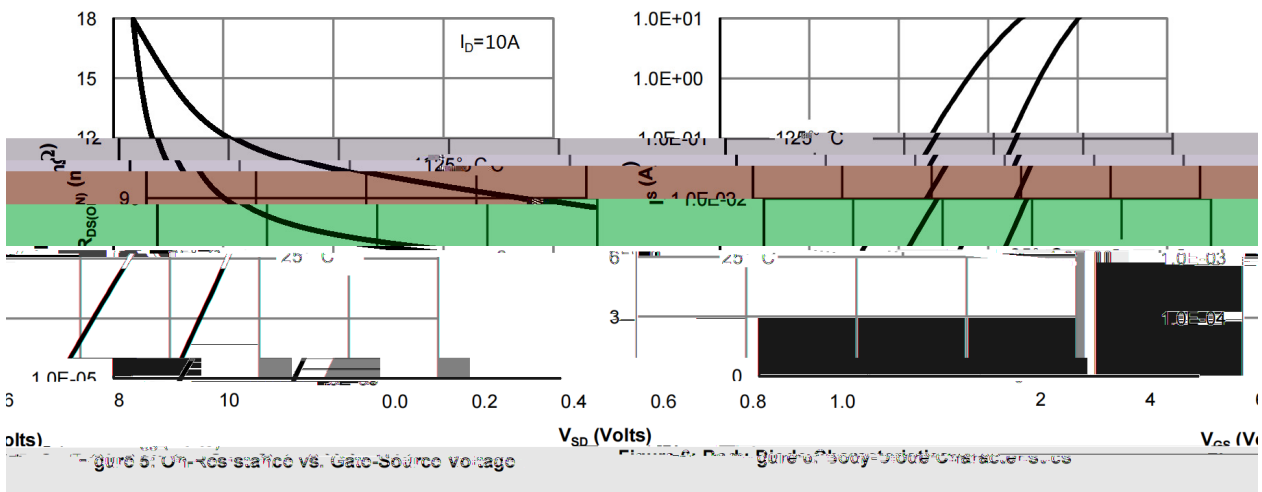
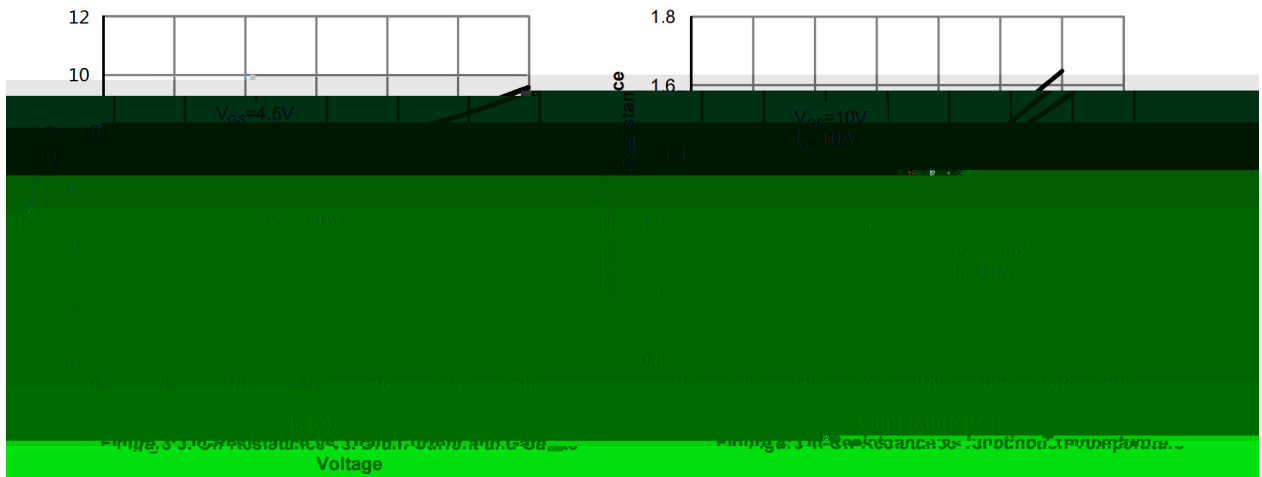
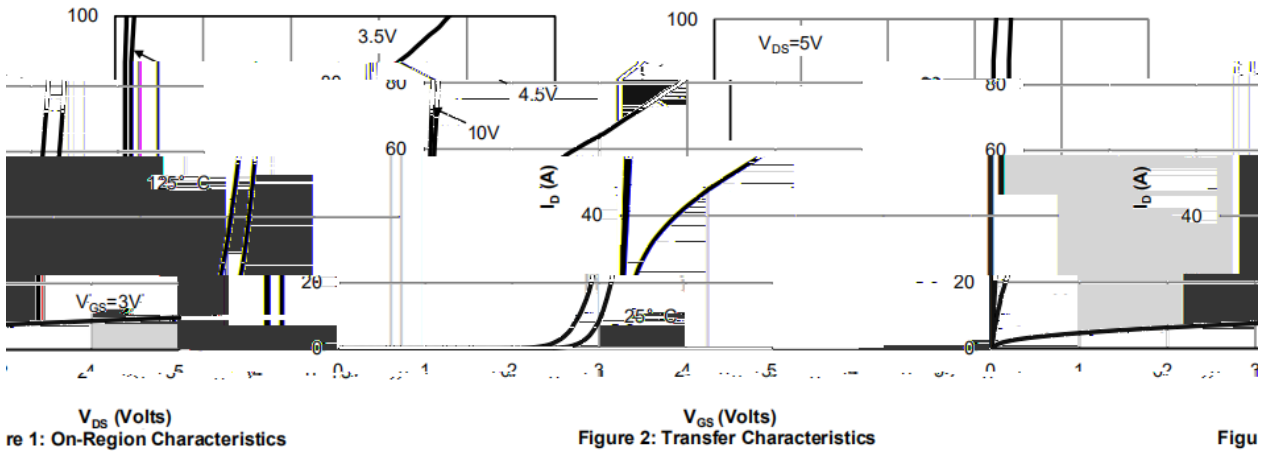
/ Electrical Characteristics($T_a=25$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	40	46		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V$			1	μA
Gate-Body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=10A$		5.6	6	m
		$V_{GS}=4.5V, I_D=10A$		7.8	9	
Diode Forward Voltage	V_{SD}	$I_S=1A, V_{GS}=0V$			1.2	V
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		990		pF
Output Capacitance	C_{oss}			390		
Reverse Transfer Capacitance	C_{rss}			42		
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1MHz$		5.2		
Total Gate Charge	$Q_{g(10V)}$	$V_{GS}=10V, V_{DS}=20V, I_D=20A$		20		nC
Total Gate Charge	$Q_{g(4.5V)}$			8.5		
Gate Source Charge	Q_{gs}			5.5		
Gate Drain Charge	Q_{gd}			3		

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10V$ $V_{DS}=20V$ $R_L=1.0\Omega$ $R_{GEN}=3\Omega$		7.5		ns
Turn-On Rise Time	t_r			2		
Turn-Off Delay Time	$t_{d(off)}$			23		
Turn-Off Fall Time	t_f			3		

/ Electrical Characteristic Curve



/ Electrical Characteristic Curve

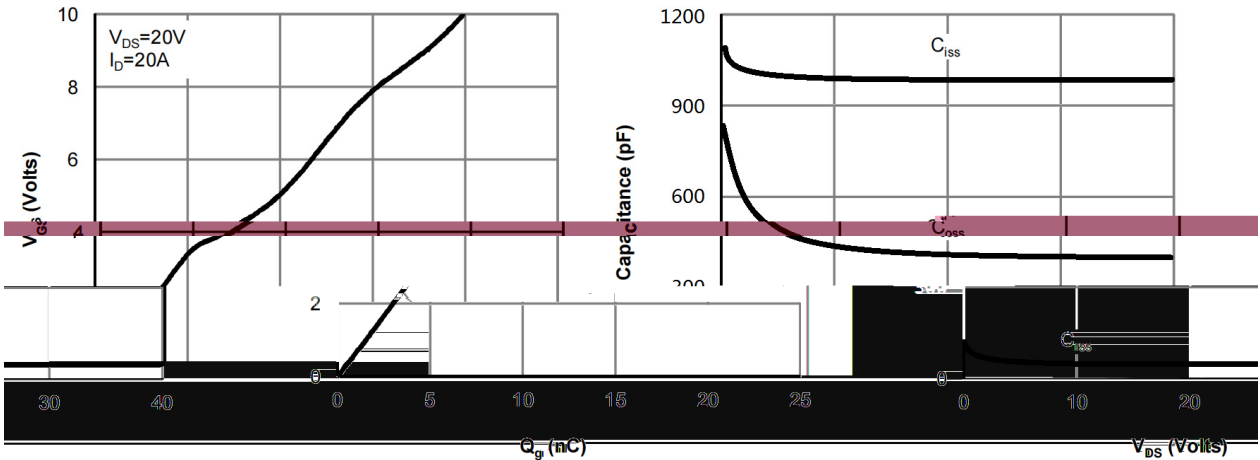


Figure 7. Gate Charge Characteristics

Figure 8. Output Characteristics

Figure 9. Capacitance Characteristics

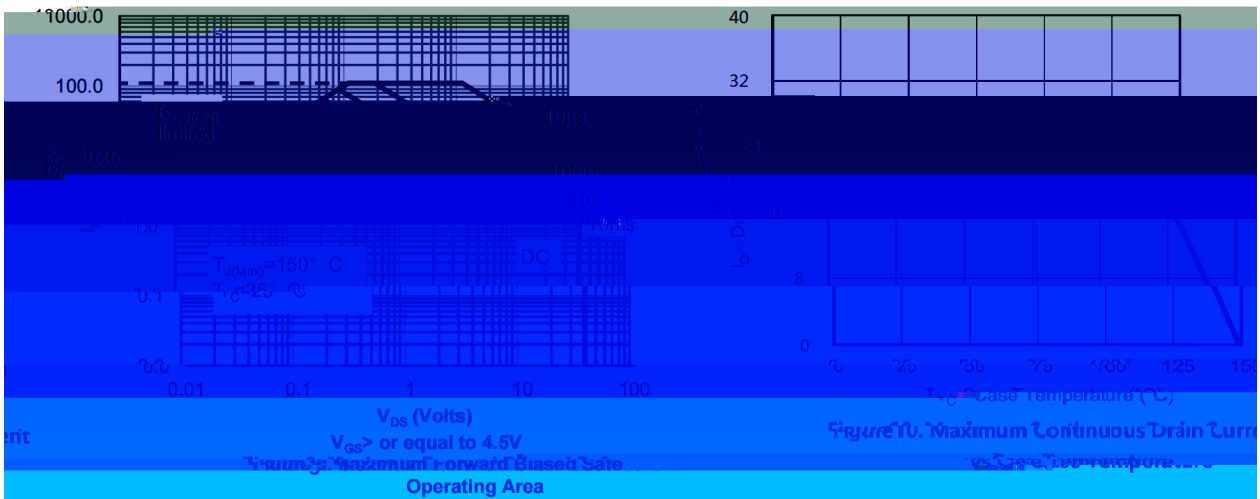


Figure 10. Maximum Continuous Drain Current vs Case Temperature

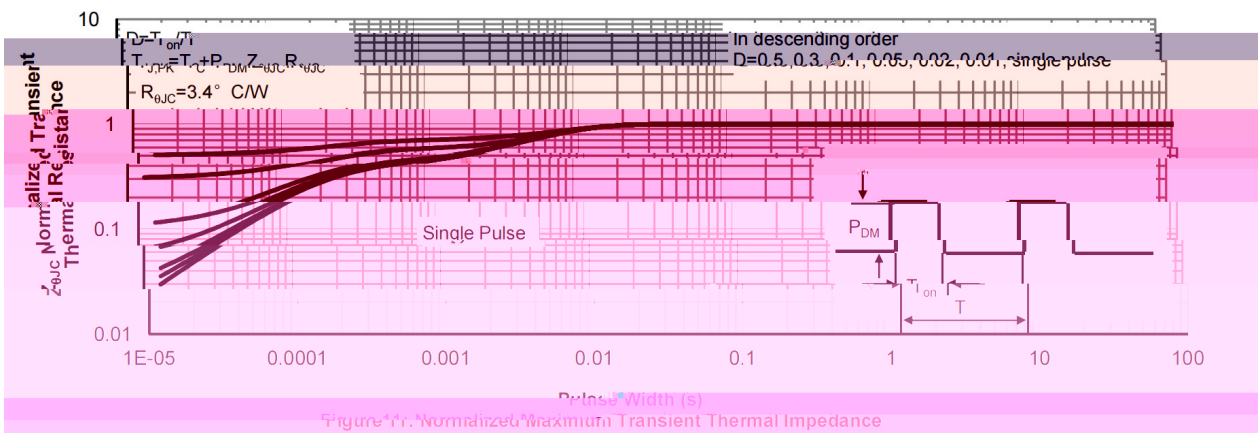
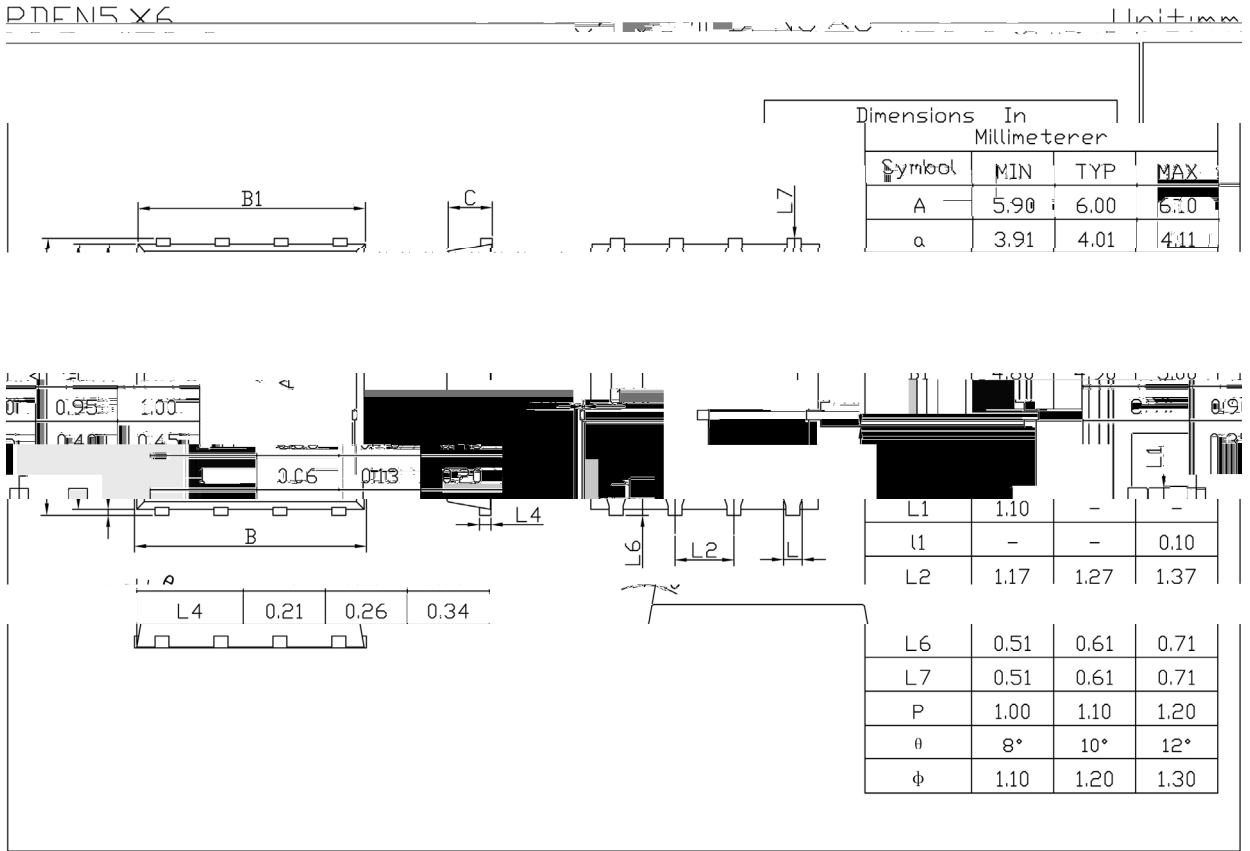


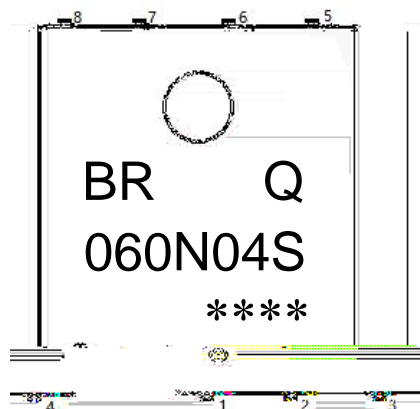
Figure 11. Normalized Maximum Transient Thermal Impedance

/ Package Dimensions



Rev.00 201812

/ Marking Instructions



060N04S

Note

BR	Company Code
Q:	Automobile halogen-free product Code
060N04S	Product Type
****:	Lot No. Code, code change with Lot No

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

Note:

- 1 150 200 60 120sec; 1.Preheating:150~200 , Time:60~120sec.
- 2 255 5 5 0.5sec; 2.Peak 0.5sec; 2.PQ